



Supplemental Application Data Sheet

Application Information

Application number::	<u>10/763,561</u>
Filing Date::	<u>01/22/04</u>
Application Type::	Regular
Subject Matter::	Utility
Suggested Group Art Unit::	N/A
CD-ROM or CD-R?::	None
Sequence submission?::	None
Computer Readable Form (CRF)?::	No
Title::	DISTRIBUTED CURRENT SOURCES FOR FOLDING ADC AMPLIFIER STAGES
Attorney Docket Number::	08211/0200350-US0/P05787
Request for Early Publication?::	No
Request for Non-Publication?::	Yes
Total Drawing Sheets::	6
Small Entity?::	No
Petition included?::	No
Secrecy Order in Parent Appl.?::	No

Applicant Information

Applicant Authority Type::	Inventor
Primary Citizenship Country::	US
Status::	Full Capacity
Given Name::	Christopher
Middle Name::	Alan
Family Name::	Menkus
City of Residence::	Munich
Country of Residence::	Germany
Street of mailing address::	Nordendstr. 49
City of mailing address::	Munich

Country of mailing address:: Germany

Postal or Zip Code of mailing address:: D-80801

Applicant Authority Type:: Inventor

Primary Citizenship Country:: US

Status:: Full Capacity

Given Name:: Robert

Middle Name:: Callaghan

Family Name:: Taft

City of Residence:: Munich

Country of Residence:: Germany

Street of mailing address:: Koeniginstr. 37, App. 212

City of mailing address:: Munich

Country of mailing address:: Germany

Postal or Zip Code of mailing address:: D-80539

Correspondence Information

Correspondence Customer Number:: 38845

Representative Information

Representative Customer Number:: 38845

Assignee Information

Assignee name:: National Semiconductor Corporation

Street of mailing address:: 2900 Semiconductor Drive

City of mailing address:: Santa Clara

State or Province of mailing address:: CA

Postal or Zip Code of mailing address:: 95051-8090